

/ Descriptions

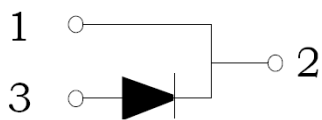
WR0553DF

/ Features

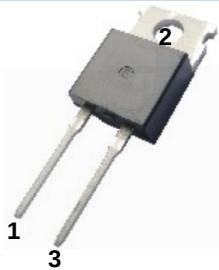
/ Applications

XSV

/ Equivalent Circuit



/ Pinning

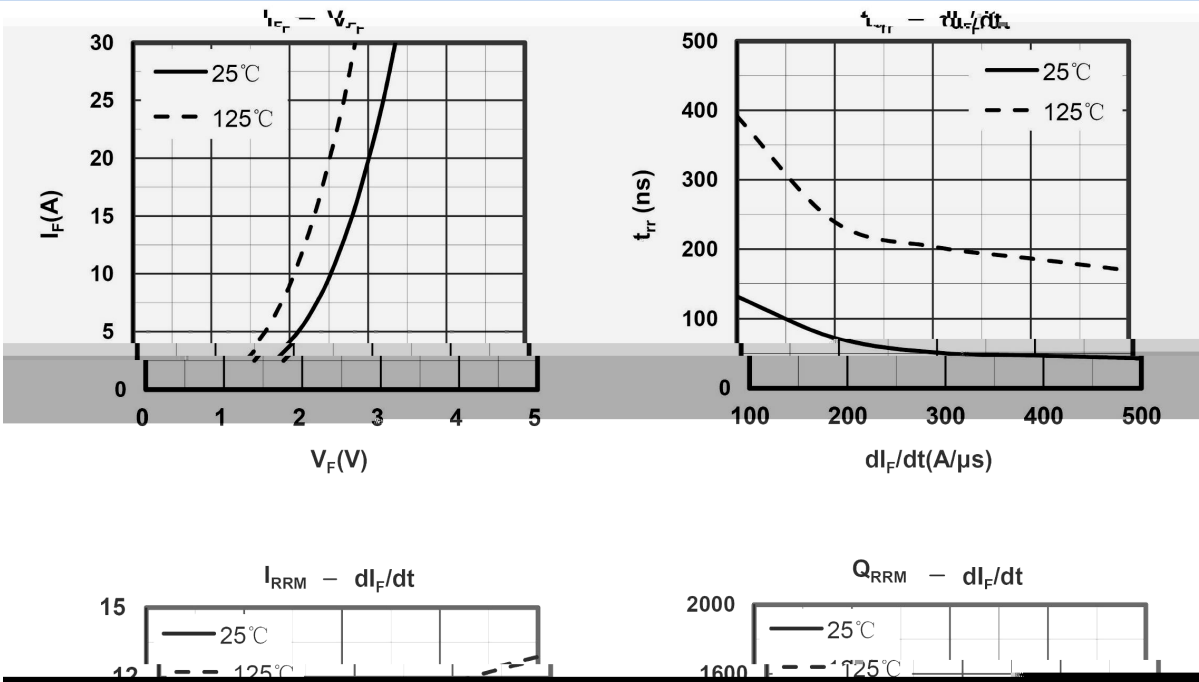


/ h_{FE} Classifications & Marking

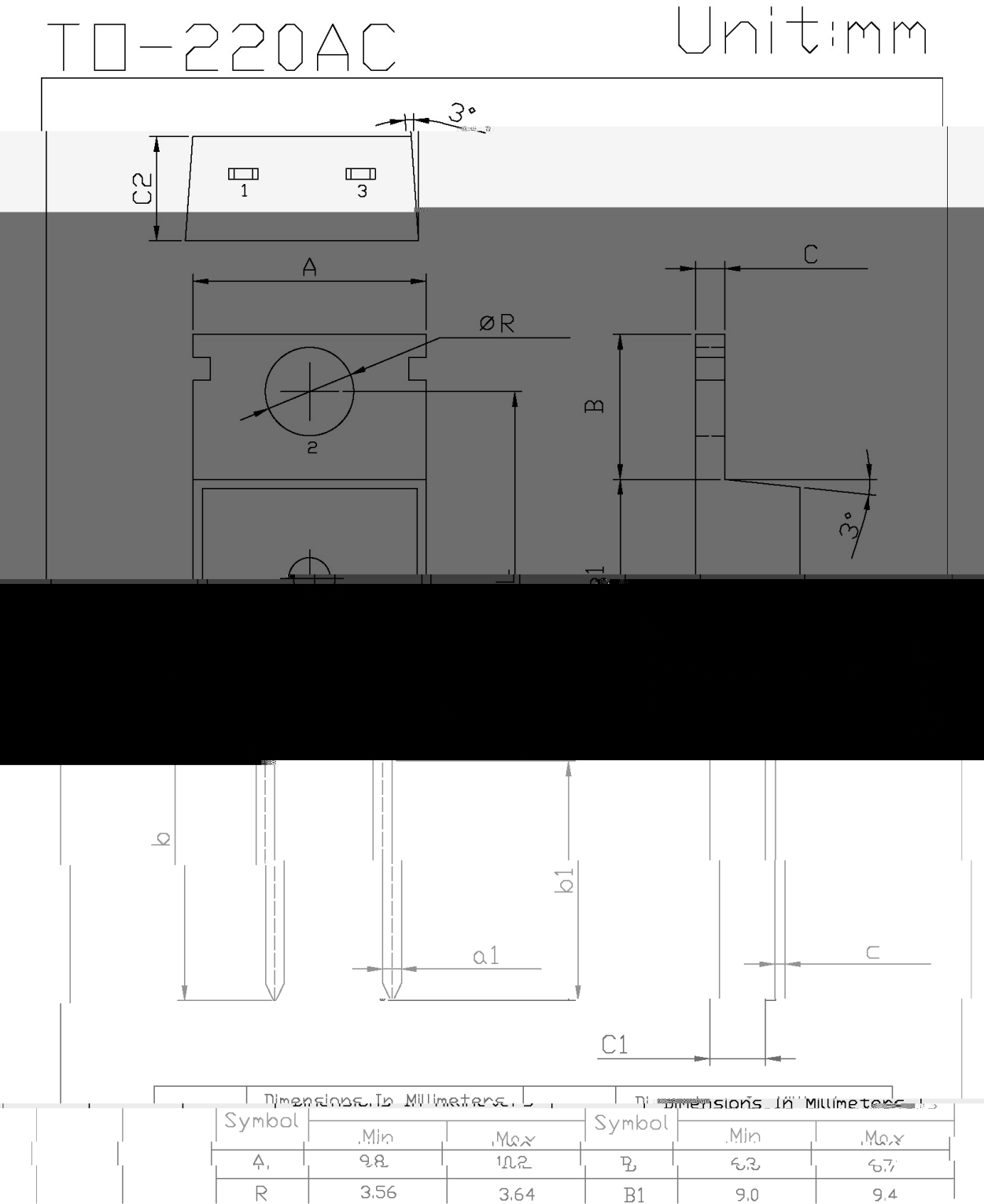
	θ		

		μ				

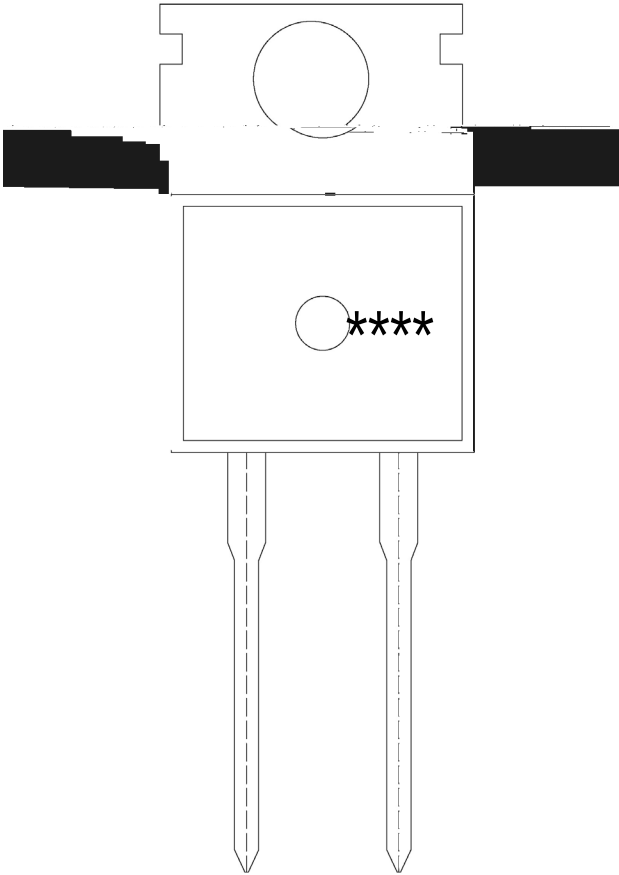
/ Electrical Characteristic Curve



/ Package Dimensions

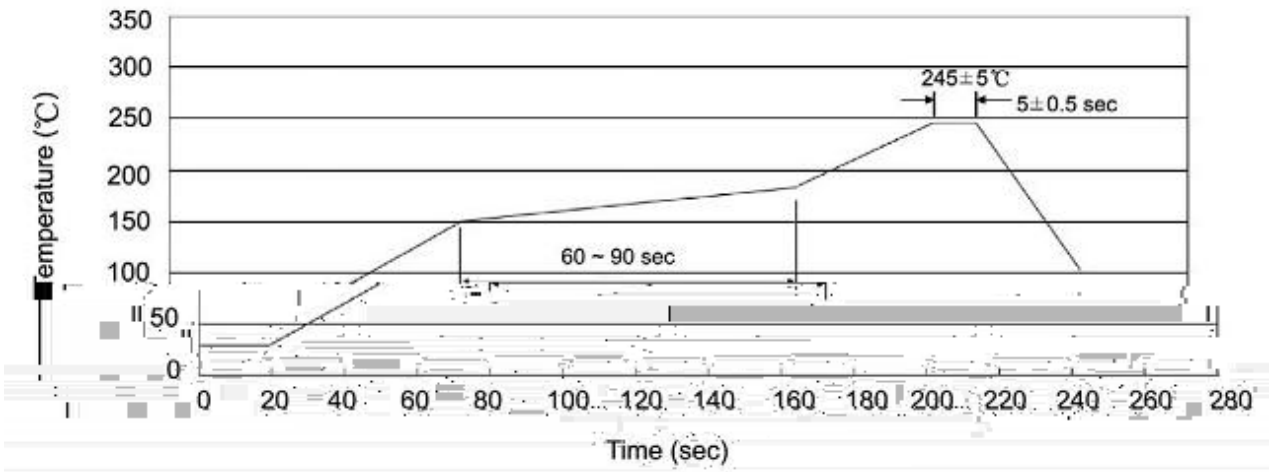


/ Marking Instructions



EU
P XU48453

() / Temperature Profile for Dip Soldering(Pb-Free)



2 3/8 2 3/8 2 3/8 2 3/8

/ Resistance to Soldering Heat Test Conditions

2 3/8 2

/ Packaging SPEC.

封装形式	包装数量					包装尺寸 :		
	Units/Bag 只/袋	Bags/Inner Box 袋/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Bag 袋	Inner Box 盒	Outer Box 箱
TO-220/F/AC	200	10	2,000	5	10,000	135×190	237×172×102	560×245×195

封装形式	包装数量					包装尺寸 :		
	Units/Tube 只/套管	Tubes/Inner Box 套管/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Tube 套管	Inner Box 盒	Outer Box 箱
TO-220/F/AC	50	20	1,000	5	5,000	532×31.4×5.5	555×164×50	575×290×180

/ Notices